© Copyright 2005. IPC, Bannoc	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.							
1752-21.1 IPC Web Site for Information on http://www.ipc.org/IPC-175x	IPC Web Site for Information on IPC-1752 Standard Form Ty http://www.ipc.org/IPC-175x Distribu			* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materia				ials and M	als and Mfg Information			
Supplier Information												
ompany name* Company unique ID				Unique ID Authority				Response Date*				
onsemi	i							2025-08-01				
Contact Name	Title - Contact			Phone - Contact*				Email - Contact*				
Product-Env-Stewards	-Env-Stewards Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com				
Authorized Representative*	uthorized Representative* Title - Representative			Phone - Representative*				Email - Representative*				
Product-Env-Stewards Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
Requester Item Number Mfr Ite	m Number	Mfr Item Name		Ef	fective Date	Version	Manufacturing Site		Weight*	UOM	Unit Type	
N24S6	BC4DYT3G New OPN N24S64B EEPROM in thin CS		BC4DYT3G - 64KB I CSP package	2C 20	25-08-01		CNQ	(	).3803	mg	Each	
Manufacturing Proccess Information												
Terminal Plating / Grid Array Material	Grid Array Material Terminal Base Alloy J-		-STD-020 MSL Rating		Peak Process Body Temperatur		ature Max Time at Peak	Temperat	ure Numbe	er of Reflow Cyc	cles	
SnAgCu	SnAgCu CU Alloy 1				260	С	30	secon	ds 3			
Comments												
level 1 - maximum time at peak temperature during	oldering is 10-3	0 seconds										
For more information regarding material composition	n please refer to	page 3										

RoHS Material Composition Declaration				Declaration Type *	Detailed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DIP).									
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of					
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted					
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all					
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the					
Supplier Digital Signature Ra	stislav Drska	Le								

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Backside Protection Film	0.0211	mg		Epoxy resin	proprietary data		0.0044	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0004	mg
			Supplier	Acrylic resins	Proprietary Data		0.0044	mg
			Supplier	Silica (SiO2)	14464-46-1		0.0119	mg
Die	0.271	mg	Supplier	Silicon (Si)	7440-21-3		0.271	mg
Protection coat	0.0169	mg		Polyimide	proprietary data		0.0169	mg
RDL	0.013	mg	Supplier	Titanium (Ti)	7440-32-6		0.0001	mg
			Supplier	Copper (Cu)	7440-50-8		0.0129	mg
Solder Ball	0.0448	mg	Supplier	Silver (Ag)	7440-22-4		0.0018	mg
			Supplier	Tin (Sn)	7440-31-5		0.0428	mg
			Supplier	Copper (Cu)	7440-50-8		0.0002	mg
Under Bump Metal	0.0135	mg	Supplier	Titanium (Ti)	7440-32-6		0.0001	mg
			Supplier	Copper (Cu)	7440-50-8		0.0134	mg